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**FAIRCHILD**

SEMICONDUCTOR™

July 1988
Revised August 2000

# 100325

# Low Power Hex ECL-to-TTL Translator

## General Description

The 100325 is a hex translator for converting F100K logic levels to TTL logic levels. Differential inputs allow each circuit to be used as an inverting, non-inverting or differential receiver. An internal reference voltage generator provides $V_{BB}$ for single-ended operation, or for use in Schmitt trigger applications. All inputs have 50kΩ pull-down resistors. When the inputs are either unconnected or at the same potential the outputs will go LOW.

When used in single-ended operation the apparent input threshold of the true inputs is 20mV to 40mV higher (positive) than the threshold of the complementary inputs. The $V_{EE}$ and $V_{TTL}$ power may be applied in either order.

## Features

■ Pin/function compatible with 100125
■ Meets 100125 AC specifications
■ 50% power reduction of the 100125
■ Differential inputs with built in offset
■ Standard FAST® outputs
■ 2000V ESD protection
■ −4.2V to −5.7V operating range
■ Available to industrial grade temperature range

## Ordering Code:

| Order Number | Package Number | Package Description |
|---|---|---|
| 100325SC | M24B | 24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide |
| 100325PC | N24E | 24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-010, 0.400 Wide |
| 100325QI | V28A | 28-Lead Plastic Lead Chip Carrier (PLCC), JEDEC MO-047, 0.450 Square |
| 100325QC | V28A | 28-Lead Plastic Lead Chip Carrier (PLCC), JEDEC MO-047, 0.450 Square Industrial Temperature Range (−40°C to +85°C) |

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

## Connection Diagrams

**24-Pin DIP/SOIC**
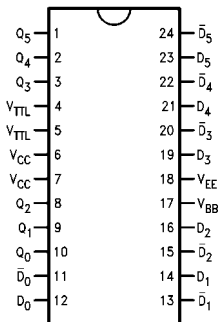
**28-Pin PLCC**
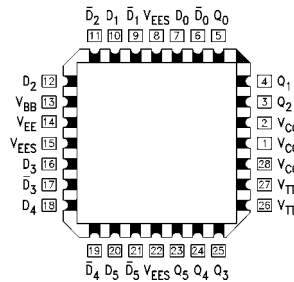


## Pin Descriptions

| Pin Names | Description |
|---|---|
| $D_0$–$D_5$ | Data Inputs |
| $\overline{D}_0$–$\overline{D}_5$ | Inverting Data Inputs |
| $Q_0$–$Q_5$ | Data Outputs |

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**100325**

## Truth Table

| Inputs | | Outputs |
|---|---|---|
| $D_n$ | $\overline{D}_n$ | $Q_n$ |
| L | H | L |
| H | L | H |
| L | L | L |
| H | H | L |
| | | |
| OPEN | OPEN | L |
| $V_{EE}$ | $V_{EE}$ | L |
| L | $V_{BB}$ | L |
| H | $V_{BB}$ | H |
| $V_{BB}$ | L | H |
| $V_{BB}$ | H | L |

H = HIGH Voltage Level
L = LOW Voltage Level

## Logic Diagram

## Absolute Maximum Ratings(Note 1)

| | |
|---|---|
| Storage Temperature ($T_{STG}$) | −65°C to +150°C |
| Maximum Junction Temperature ($T_J$) | +150°C |
| $V_{EE}$ Pin Potential to Ground Pin | −7.0V to +0.5V |
| $V_{TTL}$ Pin Potential to Ground Pin | −0.5V to +6.0V |
| Input Voltage (DC) | $V_{EE}$ to +0.5V |
| Voltage Applied to Output | |
| in HIGH State (with $V_{CC}$ = 0V) | −0.5V to $V_{CC}$ |
| Current Applied to Output | |
| in LOW State (Max) | twice the rated $I_{OL}$ (mA) |
| ESD (Note 2) | ≥2000V |

## Recommended Operating Conditions

| | |
|---|---|
| Case Temperature ($T_C$) | |
| Commercial | 0°C to +85°C |
| Industrial | −40°C to +85°C |
| Supply Voltage ($V_{EE}$) | −5.7V to −4.2V |

**Note 1:** The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum rating. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

**Note 2:** ESD testing conforms to MIL-STD-883, Method 3015.

## Commercial Version

## DC Electrical Characteristics

$V_{EE}$ = −4.2V to −5.7V, $V_{CC}$ = GND, $V_{TTL}$ = +4.5V to 5.5V, $T_C$ = 0°C to +85°C (Note 3)

| Symbol | Parameter | Min | Typ | Max | Units | Conditions | |
|---|---|---|---|---|---|---|---|
| $V_{BB}$ | Output Reference Voltage | −1380 | −1320 | −1260 | mV | $I_{VBB}$ = −2.1 mA | |
| $V_{IH}$ | Single-Ended Input HIGH Voltage | −1165 | | −870 | mV | Guaranteed HIGH Signal for All Inputs (with One Input Tied to $V_{BB}$) | |
| $V_{IL}$ | Single-Ended Input LOW Voltage | −1830 | | −1475 | mV | Guaranteed LOW Signal for All Inputs (with One Input Tied to $V_{BB}$) | |
| $V_{OH}$ | Output HIGH Voltage | 2.5 | | | V | $I_{OH}$ = −2.0 mA | $V_{IN}$ = $V_{IH\,(Max)}$ |
| $V_{OL}$ | Output LOW Voltage | | | 0.5 | V | $I_{OL}$ = 20 mA | or $V_{IL\,(Min)}$ |
| $V_{DIFF}$ | Input Voltage Differential | 150 | | | mV | Required for Full Output Swing | |
| $V_{CM}$ | Common Mode Voltage | $V_{CC}$ − 2.0 | | $V_{CC}$ − 0.5 | V | | |
| $I_{IH}$ | Input HIGH Current | | | 350 | µA | $V_{IN}$ = $V_{IH\,(Max)}$, $D_0$–$D_5$ = $V_{BB}$, $\overline{D}_0$–$\overline{D}_5$ = $V_{IL\,(Min)}$ | |
| $I_{IL}$ | Input LOW Current | 0.5 | | | µA | $V_{IN}$ = $V_{IL\,(Min)}$, $D_0$–$D_5$ = $V_{BB}$ | |
| $I_{OS}$ | Output Short-Circuit Current | −150 | | −60 | mA | $V_{OUT}$ = GND (Note 4) | |
| $I_{EE}$ | $V_{EE}$ Power Supply Current | −37 | −27 | −17 | mA | $D_0$–$D_5$ = $V_{BB}$ | |
| $I_{TTL}$ | $V_{TTL}$ Power Supply Current | | 45 | 65 | mA | $D_0$–$D_5$ = $V_{BB}$ | |

**Note 3:** The specified limits represent the "worst case" value for the parameter. Since these values normally occur at the temperature extremes, additional noise immunity and guardbanding can be achieved by decreasing the allowable system operating ranges. Conditions for testing shown in the tables are chosen to guarantee operation under "worst case" conditions.

**Note 4:** Test one output at a time.

## DIP AC Electrical Characteristics

$V_{EE}$ = −4.2V to −5.7V, $V_{CC}$ = GND, $V_{TTL}$ = +4.5V to +5.5V

| Symbol | Parameter | $T_C$ = 0°C | | $T_C$ = +25°C | | $T_C$ = +85°C | | Units | Conditions |
|---|---|---|---|---|---|---|---|---|---|
| | | Min | Max | Min | Max | Min | Max | | |
| $t_{PLH}$ $t_{PHL}$ | Propagation Delay Data to Output | 0.80 | 3.50 | 0.90 | 3.70 | 1.00 | 4.00 | ns | $C_L$ = 15 pF Figures 1, 2 |
| $t_{PLH}$ $t_{PHL}$ | Propagation Delay Data to Output | 1.60 | 4.30 | 1.70 | 4.50 | 1.80 | 4.80 | ns | $C_L$ = 50 pF Figures 1, 3 |

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# Commercial Version (Continued)
## SOIC and PLCC AC Electrical Characteristics

$V_{EE} = -4.2V$ to $-5.7V$, $V_{CC} = GND$, $V_{TTL} = +4.5V$ to $+5.5V$

| Symbol | Parameter | $T_C = 0°C$ | | $T_C = +25°C$ | | $T_C = +85°C$ | | Units | Conditions |
|---|---|---|---|---|---|---|---|---|---|
| | | Min | Max | Min | Max | Min | Max | | |
| $t_{PLH}$ $t_{PHL}$ | Propagation Delay Data to Output | 0.80 | 3.30 | 0.90 | 3.50 | 1.00 | 3.80 | ns | $C_L = 15$ pF Figures 1, 2 |
| $t_{PLH}$ $t_{PHL}$ | Propagation Delay Data to Output | 1.60 | 4.10 | 1.70 | 4.30 | 1.80 | 4.60 | ns | $C_L = 50$ pF Figures 1, 3 |
| $t_{OSHL}$ | Maximum Skew Common Edge Output-to-Output Variation Data to Output Path | | 0.65 | | 0.65 | | 0.65 | ns | PLCC Only (Note 5) |
| $t_{OSLH}$ | Maximum Skew Common Edge Output-to-Output Variation Data to Output Path | | 0.65 | | 0.65 | | 0.65 | ns | PLCC Only (Note 5) |
| $t_{OST}$ | Maximum Skew Opposite Edge Output-to-Output Variation Data to Output Path | | 2.20 | | 2.20 | | 2.20 | ns | PLCC Only (Note 5) |
| $t_{PS}$ | Maximum Skew Pin (Signal) Transition Variation Data to Output Path | | 2.10 | | 2.10 | | 2.10 | ns | PLCC Only (Note 5) |

**Note 5:** Output-to-Output Skew is defined as the absolute value of the difference between the actual propagation delay for any outputs within the same packaged device. The specifications apply to any outputs switching in the same direction either HIGH-to-LOW ($t_{OSHL}$), or LOW-to-HIGH ($t_{OSLH}$), or in opposite directions both HL and LH ($t_{OST}$). Parameters $t_{OST}$ and $t_{PS}$ guaranteed by design.

## Industrial Version

# PLCC DC Electrical Characteristics

$V_{EE} = -4.2V$ to $-5.7V$, $V_{CC} = GND$, $T_C = -40°C$ to $+85°C$ (Note 6)

| Symbol | Parameter | $T_C = -40°C$ | | $T_C = 0°C$ to $+85°C$ | | Units | Conditions | |
|---|---|---|---|---|---|---|---|---|
| | | Min | Max | Min | Max | | | |
| $V_{BB}$ | Output Reference Voltage | −1395 | −1255 | −1380 | −1260 | mV | $I_{VBB} = -2.1$ mA | |
| $V_{IH}$ | Single-Ended Input HIGH Voltage | −1170 | −870 | −1165 | −870 | mV | Guaranteed HIGH Signal for All Inputs (with One Input Tied to $V_{BB}$) | |
| $V_{IL}$ | Single-Ended Input LOW Voltage | −1830 | −1480 | −1830 | −1475 | mV | Guaranteed LOW Signal for All Inputs (with One Input Tied to $V_{BB}$) | |
| $V_{OH}$ | Output HIGH Voltage | 2.5 | | 2.5 | | V | $I_{OH} = -2.0$ mA | $V_{IN} = V_{IH\ (Max)}$ |
| $V_{OL}$ | Output LOW Voltage | | 0.5 | | 0.5 | V | $I_{OL} = 20$ mA | or $V_{IL\ (Min)}$ |
| $V_{DIFF}$ | Input Voltage Differential | 150 | | 150 | | mV | Required for Full Output Swing | |
| $V_{CM}$ | Common Mode Voltage | $V_{CC} - 2.0$ | $V_{CC} - 0.5$ | $V_{CC} - 2.0$ | $V_{CC} - 0.5$ | V | | |
| $I_{IH}$ | Input HIGH Current | | 450 | | 350 | μA | $V_{IN} = V_{IH\ (Max)}$, $D_0–D_5 = V_{BB}$, $\overline{D}_0–\overline{D}_5 = V_{IL\ (Min)}$ | |
| $I_{IL}$ | Input LOW Current | 0.5 | | 0.5 | | μA | $V_{IN} = V_{IL\ (Min)}$, $D_0–D_5 = V_{BB}$ | |
| $I_{OS}$ | Output Short-Circuit Current | −150 | −60 | −150 | −60 | mA | $V_{OUT} = GND$ (Note 7) | |
| $I_{EE}$ | $V_{EE}$ Power Supply Current | −37 | −15 | −37 | −17 | mA | $D_0–D_5 = V_{BB}$ | |
| $I_{TTL}$ | $V_{TTL}$ Power Supply Current | | 65 | | 65 | mA | $D_0–D_5 = V_{BB}$ | |

**Note 6:** The specified limits represent the "worst case" value for the parameter. Since these values normally occur at the temperature extremes, additional noise immunity and guardbanding can be achieved by decreasing the allowable system operating ranges. Conditions for testing shown in the tables are chosen to guarantee operation under "worst case" conditions.

**Note 7:** Test one output at a time.

# PLCC AC Electrical Characteristics

$V_{EE} = -4.2V$ to $-5.7V$, $V_{CC} = GND$, $V_{TTL} = +4.5V$ to $+5.5V$

| Symbol | Parameter | $T_C = -40°C$ | | $T_C = +25°C$ | | $T_C = +85°C$ | | Units | Conditions |
|---|---|---|---|---|---|---|---|---|---|
| | | Min | Max | Min | Max | Min | Max | | |
| $t_{PLH}$ $t_{PHL}$ | Propagation Delay Data to Output | 0.80 | 3.30 | 0.90 | 3.50 | 1.00 | 3.80 | ns | $C_L = 15$ pF Figures 1, 2 |
| $t_{PLH}$ $t_{PHL}$ | Propagation Delay Data to Output | 1.60 | 4.10 | 1.70 | 4.30 | 1.80 | 4.60 | ns | $C_L = 50$ pF Figures 1, 3 |

## Switching Waveform



**FIGURE 1. Propagation Delay**

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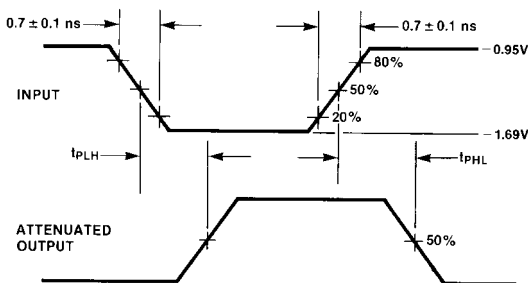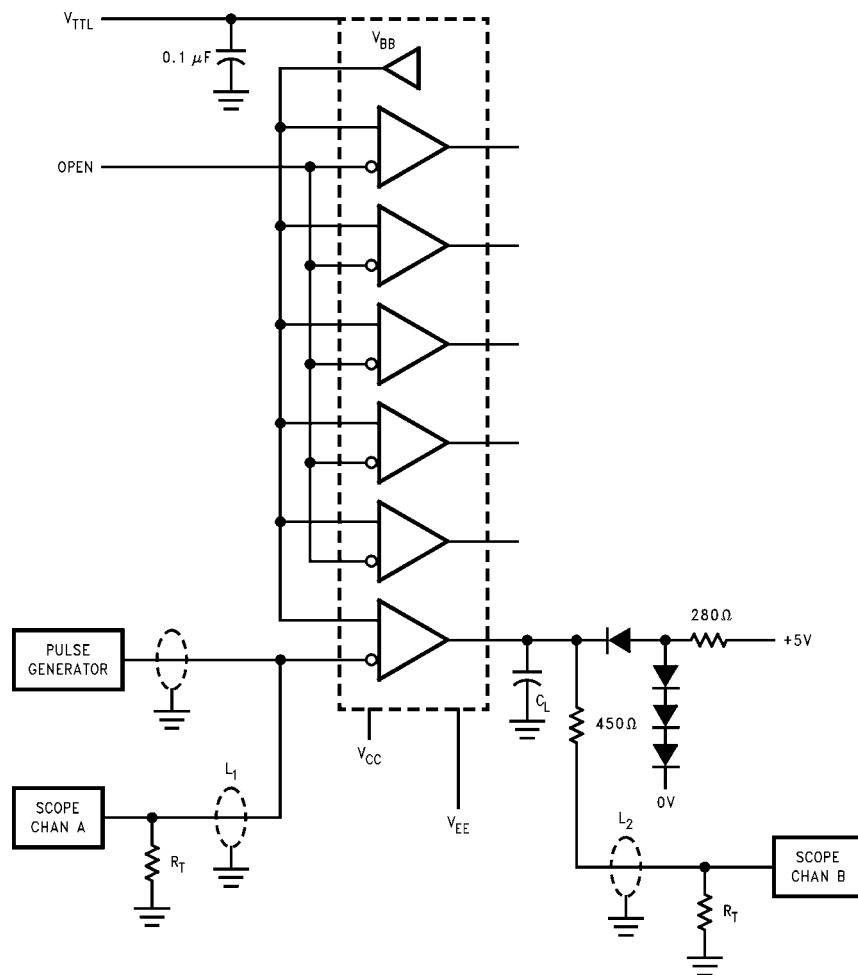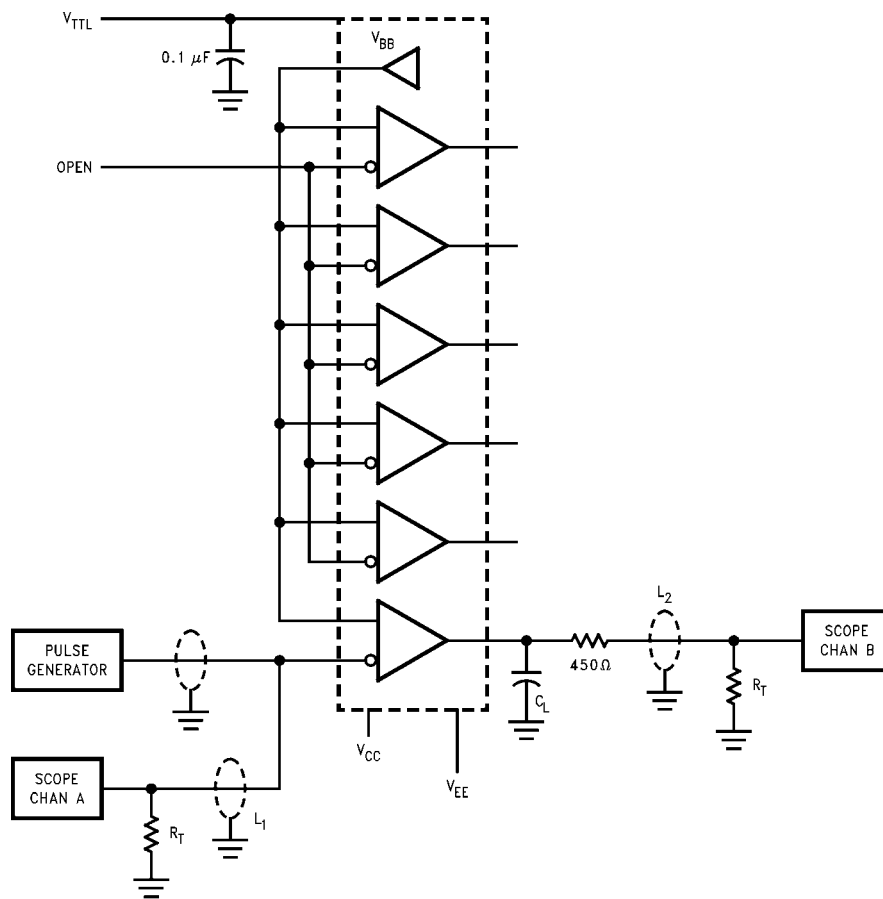
## Test Circuits



**Note:**
- $V_{CC} = 0V$, $V_{EE} = -4.5V$, $V_{TTL} = +5V$
- L1 and L2 = equal length 50Ω impedance lines
- $R_T$ = 50Ω terminator internal to scope
- Decoupling 0.1 μF from GND to $V_{CC}$, $V_{EE}$ and $V_{TTL}$
- All unused outputs are loaded with 500Ω to GND
- $C_L$ = Fixture and stray capacitance = 15 pF

**FIGURE 2. AC Test Circuit for 15 pF Loading**

## Test Circuits (Continued)



**Note:**

- $V_{CC} = 0V$, $V_{EE} = -4.5V$, $V_{TTL} = +5V$
- L1 and L2 = equal length 50Ω impedance lines
- $R_T = 50\Omega$ terminator internal to scope
- Decoupling 0.1 μF from GND to $V_{CC}$, $V_{EE}$ and $V_{TTL}$
- All unused outputs are loaded with 500Ω to GND
- $C_L$ = Fixture and stray capacitance = 50 pF

**FIGURE 3. AC Test Circuit for 50 pF Loading**

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**Physical Dimensions** inches (millimeters) unless otherwise noted
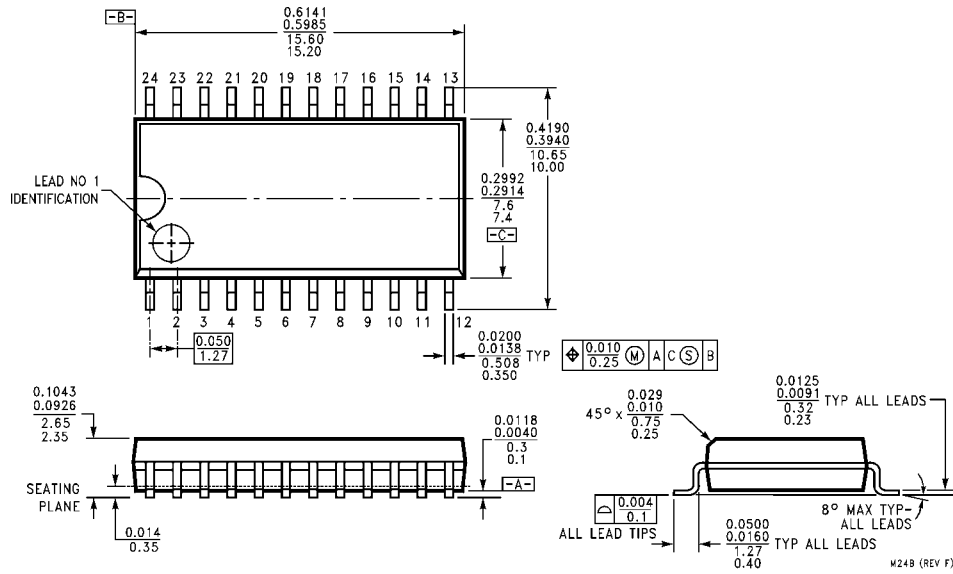


**24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide**
**Package Number M24B**
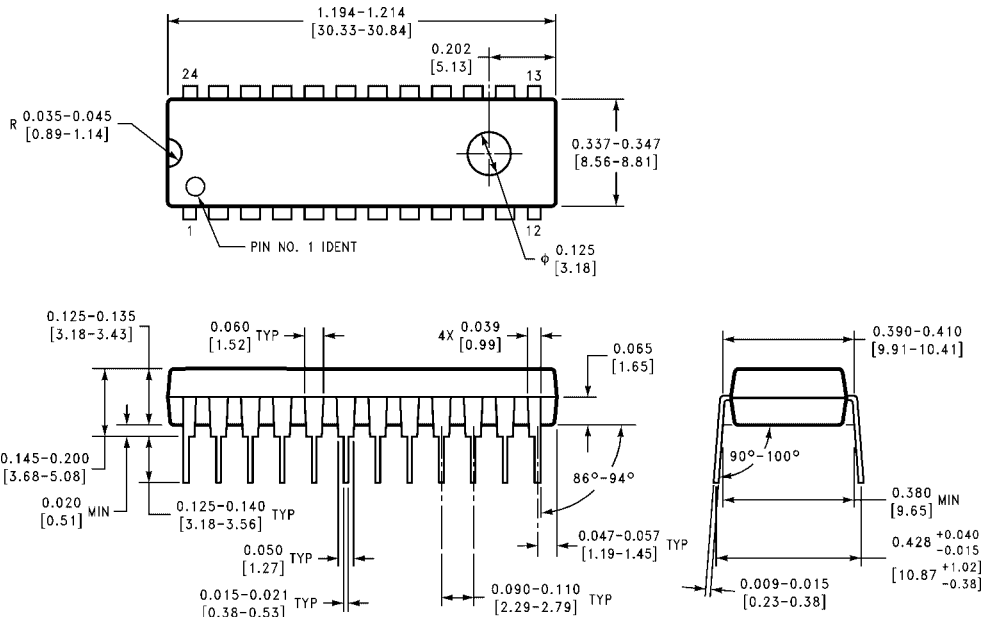


**24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-010, 0.400 Wide**
**Package Number N24E**

# Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



0.450 +0.006 −0.000
[11.43] +0.15 −0.00
PIN #1 IDENT

0.029±0.003 TYP
[0.74±0.08]

45° X 0.045
[1.14]

0.017±0.004 TYP
[0.43±0.10]

0.410±0.020 TYP
[10.41±0.51]

SEATING PLANE

0.020 MIN TYP
[0.51]

0.105±0.015 TYP
[2.67±0.38]

0.050 TYP
[1.27]

0.300 TYP
[7.62]

45° X 0.045
[1.14]

0.165−0.180 TYP
[4.19−4.57]

0.004 [0.10]

0.490±0.005 TYP
[12.45±0.13]

V28A (REV K)
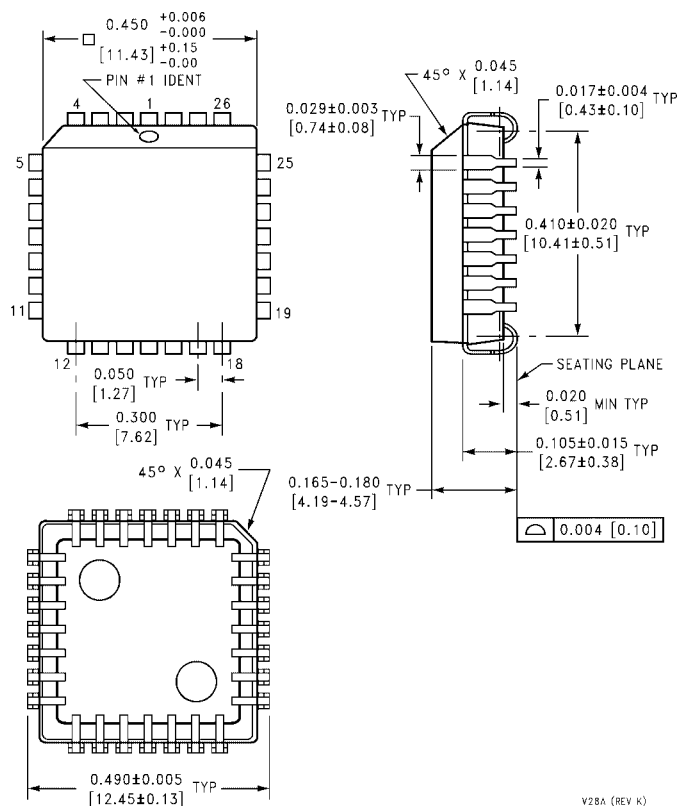
**28-Lead Plastic Lead Chip Carrier (PLCC), JEDEC MO-047, 0.450 Square
Package Number V28A**

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